Electronic Patent Application Fee Transmittal							
Application Number:	10	10784888					
Filing Date:	24-Feb-2004						
Title of Invention:	Manufacturing method of semiconductor device with chamfering						
First Named Inventor/Applicant Name:	Akira Suzuki						
Filer:	Adam Chad Lilling/Wendy Rodriguez						
Attorney Docket Number:	606402016900						
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Claims in excess of 20		1202	2	50	100		
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			100